TOSHIBA PHOTOCOUPLER GaAłAs Ired & PHOTO-IC

# **TLP2116**

- Plasma Display Panels (PDP)
- High-Speed Interfaces
- Factory Automation (FA)

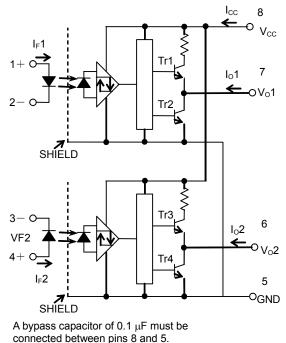
The TOSHIBA TLP2116 dual photocoupler consists of a pair of GaAlAs light-emitting diodes optically coupled to integrated high gain and high-speed photodetectors.

- Inverter logic (totem-pole output)
- Package: SO-8
- Guaranteed performance over temperature : -40 to 100°C
- Power supply voltage: 4.5 to 5.5 V •
- Input thresholds current: IFHL = 5 mA (max) •
- Propagation delay time (tpHL/tpLH): 75 ns (max) •
- Switching speed: 15 MBd (typ.)(NRZ)
- Common mode transient immunity: ±10 kV/µs
- Isolation voltage: 2500 Vrms

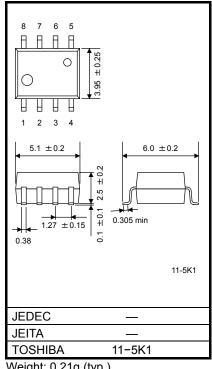
#### **Truth Table**

Input	LED1(2)	Tr1(3)	Tr2(4)	Output 1(2)
Н	ON	OFF	ON	L
L	OFF	ON	OFF	Н

### Schematic

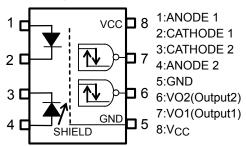


Unit: mm



Weight: 0.21g (typ.)

### **Pin Configuration (Top View)**



Absolute Maximum Ratings (Ta=25°C)

	Character	Symbol	Rating	Unit	
	Forward current	(Each Channel)	١ <sub>F</sub>	20	mA
ED	Forward current derating	(Ta $\ge$ 85°C) (Each Channel)	⊿I <sub>F</sub> /⊿Ta	-0.5	mA/°C
ш	Peak transient forward current	(Each Channel) (Note 2)	I <sub>FPT</sub>	1	А
	Reverse voltage	(Each Channel)	V <sub>R</sub>	5	V
R	Output current	(Each Channel)	lo	10	mA
DETECTOR	Output voltage	(Each Channel)	Vo	6	V
ETE	Supply voltage		V <sub>CC</sub>	6	V
Ω	Output power dissipation		PO	40	mW
Opera	ating temperature range	T <sub>opr</sub>	-40 to 100	°C	
Stora	ge temperature range	T <sub>stg</sub>	-55 to 125	°C	
Lead	solder temperature	T <sub>sol</sub>	260	°C	
Isolat	tion voltage (AC,1min., R.H. $\leq$ 6	BVS	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width PW  $\leq$  1  $\mu$ s, 300pps.

Note 2: This device is regarded as a two terminal device : pins 1, 2, 3 and 4 are shorted together, as are pins 5, 6, 7 and 8.

## **Recommended Operating Conditions**

Character	Symbol	Min	Тур.	Max	Unit	
Input current , ON	(Each Channel)	I <sub>F(ON)</sub>	8	Ι	18	mA
Input voltage , OFF	(Each Channel)	V <sub>F(OFF)</sub>	0	Ι	0.8	V
Supply voltage(*)	(Note 3)	V <sub>CC</sub>	4.5	5.0	5.5	V
Operating temperature		T <sub>opr</sub>	-40	Ι	100	°C

(\*) This item denotes operating ranges, not meaning of recommended operating conditions.

Note 3: The detector of this product requires a power supply voltage ( $V_{CC}$ ) of 4.5 V or higher for stable operation. If the  $V_{CC}$  is lower than this value, an  $I_{CCH}$  may increase, or an output may be unstable. Be sure to use the product after checking the supply current, and the operation of a power-on/-off.

Note 4: A ceramic capacitor (0.1  $\mu$ F) should be connected from pin 8 (V<sub>CC</sub>) to pin 5 (GND) to stabilize the operation of the high gain linear amplifier. Failure to provide the bypass may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

## Electrical Characteristics (Unless otherwise specified, Ta = -40 to $100^{\circ}$ C, V<sub>CC</sub> = 4.5 to 5.5V)

Characteristic		Symbol	Conditions	Min	Тур.	Max	Unit
Input forward voltage	(Each Channel)	VF	I <sub>F</sub> = 10 mA, Ta = 25°C	1.3	1.65	1.75	V
Temperature coefficient of forward voltage	(Each Channel)	⊿V <sub>F/</sub> ⊿Ta	I <sub>F</sub> = 10 mA	_	-2.0		mV/°C
Input reverse current	(Each Channel)	I <sub>R</sub>	V <sub>R</sub> = 5 V, Ta = 25°C	_	-	10	μA
Input capacitance	(Each Channel)	CT	V = 0, f = 1 MHz, Ta = 25°C	_	45	-	pF
Logic low output voltage	(Each Channel)	V <sub>OL</sub>	I <sub>OL</sub> = 1.6 mA, I <sub>F</sub> = 12 mA, V <sub>CC</sub> = 5 V	l	_	0.4	V
Logic high output voltage	(Each Channel)	V <sub>OH</sub>	I <sub>OH</sub> = -0.02 mA, V <sub>F</sub> = 1.05 V V <sub>CC</sub> = 5 V	4.0	_	Ι	V
Logic low supply current		ICCL	I <sub>F</sub> = 12 mA	Ι	_	10.0	mA
Logic high supply current		Іссн	V <sub>F</sub> = 0 V (Note 3)	-	_	10.0	mA
Input current logic low output	(Each Channel)	I <sub>FHL</sub>	I <sub>O</sub> =1.6 mA, V <sub>O</sub> < 0.4 V	_	_	5	mA
Input voltage logic high output	(Each Channel)	V <sub>FLH</sub>	I <sub>O</sub> = -0.02 mA, V <sub>O</sub> > 4.0 V	0.8	_	_	v

\*All typical values are at Ta=25°C, V<sub>CC</sub>=5 V unless otherwise specified

## Isolation Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Conditions		Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0, f = 1 MHz (Note 2)		0.8	_	pF
Isolation resistance	R <sub>S</sub>	R.H. $\leq$ 60%, V <sub>S</sub> = 500 V (Note 2)	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
		AC, 1 minute	2500	_	_	Vrms
Isolation voltage	BVS	AC, 1 second, in oil	_	5000	_	VIIIS
		DC, 1 minute, in oil	_	5000	-	Vdc

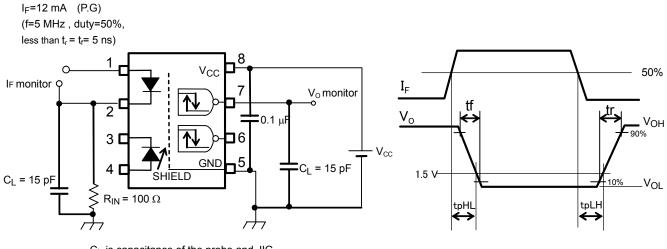
## Switching Characteristics (Unless otherwise specified, Ta = -40 to $100^{\circ}$ C, V<sub>CC</sub> = 4.5 to 5.5V)(Each Channel)

Characteristic	Symbol	Test Circuit	Conditions		Min	Тур.	Max	Unit
Propagation delay time to logic low output	t <sub>pHL</sub>	4	I <sub>F</sub> = 0→12 mA	R <sub>IN</sub> = 100 Ω	Ι	_	75	ns
Propagation delay time to logic high output	t <sub>pLH</sub>	1	I <sub>F</sub> = 12→0 mA	C <sub>L</sub> = 15 pF (Note 5)	Ι	_	75	ns
Propagation delay time to logic low output	t <sub>pHL</sub>	_	V <sub>IN</sub> = 0→5 V (I <sub>F</sub> = 0→8 mA)	R <sub>IN</sub> = 430 Ω C <sub>IN</sub> = 27 pF	Ι	_	75	ns
Propagation delay time to logic high output	t <sub>pLH</sub>	2	V <sub>IN</sub> = 5→0 V (I <sub>F</sub> = 8→0 mA)	C <sub>L</sub> = 15 pF (Note 5)	_	_	75	ns
Switching time dispersion between ON and OFF	t <sub>pHL</sub> - t <sub>pLH</sub>		I <sub>F</sub> = 12 mA R <sub>IN</sub> = C <sub>L</sub> =15 pF (Note		_	_	30	ns
Output fall time (90 - 10%)	t <sub>f</sub>	1	I <sub>F</sub> = 0→12 mA	R <sub>IN</sub> =100 Ω C <sub>L</sub> =15 pF (Note 5)	_	15	_	ns
Output rise time (10 - 90%)	t <sub>r</sub>		I <sub>F</sub> = 12→0 mA			15		ns
Common mode transient immunity at high level output	CM <sub>H</sub>	3	VC <sub>M</sub> =1000 Vp-p V <sub>O</sub> (min) = 4 V , <sup>-</sup>		10000	_	_	V/µs
Common mode transient immunity at low level output	CML	3	VC <sub>M</sub> = 1000 Vp-p V <sub>O</sub> (max) = 0.4 V	•••	-10000	_	_	V/µs

\*All typical values are at Ta=25°C

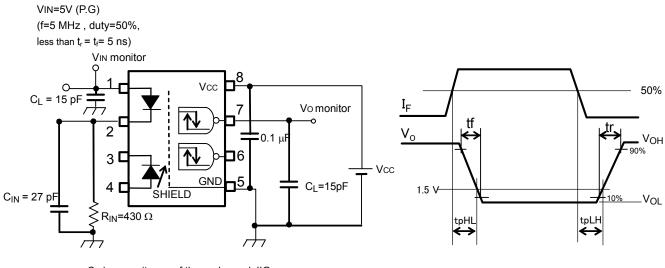
Note 5: CL is approximately 15 pF which includes probe and Jig/stray wiring capacitance.

## Test Circuit 1: Switching Time Test Circuit



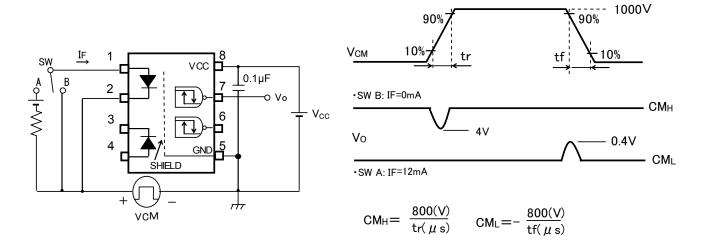
 $C_L$  is capacitance of the probe and JIG. (P.G) : Pulse Generator

#### Test Circuit 2: Switching Time Test Circuit



C<sub>L</sub> is capacitance of the probe and JIG. (P.G) : Pulse Generator

### Test Circuit 3: Common-Mode Transient Immunity Test Circuit



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